

(19) World Intellectual Property Organization  
International Bureau



(43) International Publication Date  
21 June 2007 (21.06.2007)

PCT

(10) International Publication Number  
**WO 2007/070213 A1**

(51) International Patent Classification:  
**HOIB 3/44** (2006 01) **C08L 23/16** (2006 01)

(21) International Application Number:  
PCT/US2006/044158

(22) International Filing Date:  
13 November 2006 (13 11 2006)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:  
60/749,772 13 December 2005 (13 12 2005) US

(71) Applicant (for all designated States except US): **EXXON-MOBIL CHEMICAL PATENTS INC.** [US/US], A Corporation of the State of Delaware, 5200 Bayway Drive, Baytown, TX 77520 (US)

(72) Inventors; and

(75) Inventors/Applicants (for US only): **CHASEY, Kent, Leon** [US/US], 320 Jackson Hill, Apt 471, Houston, TX 77007 (US) **DHARMARAJAN, Narayanaswami, Raja** [US/US], 16534 Town Lake Court, Houston, TX 77059 (US) **RAVISHANKAR, Periyagaram, Srinivasan** [US/US], 6006 SOARING PINE COURT, Kingwood, TX 77345 (US)

(74) Agents: **WELCH, Jeremy, P.** et al, ExxonMobil Chemical Company, PO Box 2149, Baytown, TX 77522 2149 (US)

(81) Designated States (unless otherwise indicated for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LT, LU, LV, LY, MA, MD, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RS, RU, SC, SD, SE, SG, SK, SL, SM, SV, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW

(84) Designated States (unless otherwise indicated for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, LV, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG)

**Declarations under Rule 4.17:**

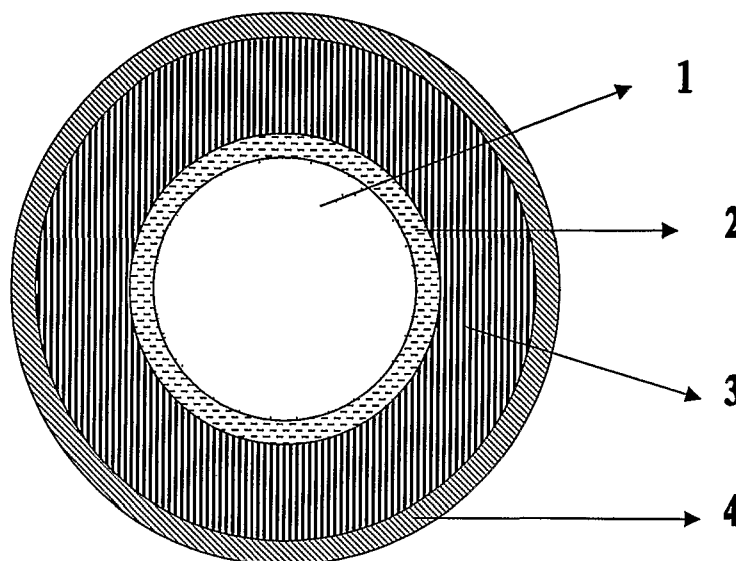
- as to applicant's entitlement to apply for and be granted a patent (Rule 4 17(u))
- as to the applicant's entitlement to claim the priority of the earlier application (Rule 4 17(u))

**Published:**

- with international search report

[Continued on next page]

(54) Title: PROPYLENE ELASTOMERS FOR ELECTRICAL WIRE AND CABLE COMPOUNDS



(57) Abstract: The present disclosure is directed to an electrical device comprising a propylene alpha olefin polymer, wherein the propylene alpha olefin polymer comprises from about 5 to about 25 wt % alpha olefin, from about 75 to about 95 wt % propylene and optionally < 10 wt% diene, wherein the propylene alpha olefin polymer has a MWD of from about 1 to about 5, a heat of fusion less than or equal to 75 J/g and a Tm < 105 °C

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— *before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments*

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## PROPYLENE ELASTOMERS FOR ELECTRICAL WIRE AND CABLE COMPOUNDS

### Field

[0001] This disclosure relates to polymer compounds for use in wire and/or cable applications.

### Background

[0002] A wide variety of polymeric materials have been utilized as electrical insulating materials for power cables and other electrical devices. Ethylene propylene co-polymers and ethylene, propylene and diene terpolymers (EPDM) having polyethylene-type crystallinity are commercially used in medium voltage electrical insulation compounds. These compounds are applied as an insulation member over either a metallic conductor or a semi-conductive substrate in a multi-step extrusion process. Typical insulating compounds may also include fillers and various additives.

[0003] EPDM polymers can provide good insulating properties. However, surface characteristics of the extrudate in a compound based on these elastomeric polymers may not be smooth at typical high extrusion rates, which is desirable because of improved interfacial adhesion between the cable layers. Therefore, one prior method attempted to reduce the extrusion rates, but it was not economically advantageous. The present disclosure provides a way to decrease the surface roughness, thereby increasing the smoothness, while maintaining high extrusion rates.

[0004] It would be desirable to have a polymeric composition suitable for use in compounds for electrical applications, such as cable coating compounds, which exhibit decreased surface roughness, improved tack and adhesion, enhanced

physical properties and/or performance, and provide improved manufacturing capability and quality, without loss of tensile strength or elongation at break.

#### Description of Figures

[0005] Figure 1 is a cross-sectional view of a typical electrical device.

#### Summary

[0006] An embodiment of this disclosure is an electrical device comprising a propylene-ethylene polymer, wherein the propylene-ethylene polymer comprises from about 5 to about 25 wt% ethylene, from about 75 to about 95 wt% propylene and optionally <10 wt% diene, wherein the propylene-ethylene polymer has a MWD of from about 1 to about 5, a heat of fusion less than or equal to 75 J/g and a  $T_m \leq 105$  °C. The electrical device may comprise an insulation layer and/or an insulation shield layer, and the propylene-ethylene polymer may be in the insulation shield layer and/or in the insulation layer.

[0007] Another embodiment of this disclosure is a process for making an electrical device comprising: providing a conductor and extruding at least one layer over the conductor, wherein at least one of the layers comprises a propylene-ethylene polymer comprising from about 5 to about 25 wt% ethylene, from about 75 to about 95 wt% propylene and optionally  $\leq 10$  wt% diene; wherein the propylene-ethylene polymer has a MWD of from about 1 to about 5, a heat of fusion less than or equal to 75 J/g and a  $T_m \leq 105$  °C.

[0008] Another embodiment of this disclosure is a cable coating compound comprising a propylene-ethylene polymer, wherein the propylene-ethylene polymer comprises from about 5 to about 25 wt% ethylene, from about 75 to about 95 wt% propylene and optionally <10 wt% diene, wherein the propylene-ethylene polymer has a MWD of from about 1 to about 5; and a  $T_m < 105$  °C.

[0009] Another embodiment of this disclosure is a wire or cable comprising a conductor and an insulation layer over the conductor; wherein the insulation layer comprises about 5 to about 10 wt% propylene-ethylene polymer, wherein the propylene-ethylene polymer, having a melting point of about 75 °C or less, and a heat of fusion of 50 J/g or less, comprises about 5-16 wt% ethylene and further comprises a second polymer wherein the second polymer is EPDM or isotactic polypropylene.

[0010] Another embodiment of this disclosure is a wire or cable comprising a conductor and an insulation layer and/or an insulation shield layer over the conductor; wherein the insulation layer and/or the insulation shield layer comprises from about 2 to about 80 wt% propylene-ethylene polymer, based on the weight of the layer, wherein the propylene-ethylene polymer, having a melting point of about 75 °C or less, and a heat of fusion of 50 J/g or less, comprises about 5-16 wt% ethylene and further comprises a second polymer wherein the second polymer is EPDM or isotactic polypropylene.

#### Description

[0011] In one embodiment, the present disclosure is directed to an electrical device comprising a conductor and one or more layers over the conductor. One or more of the layers comprises a propylene-  $\alpha$ -olefin polymer as described herein.

[0012] As shown in Figure 1, a typical wire or cable comprises a conductor (1), a conductor shield layer (2), a first layer (3), also referred to as an insulation layer, and an optional second layer (4), also referred to as an insulation shield layer. The propylene-  $\alpha$ -olefin polymer described below is particularly useful in the first layer or in the second layer or in both layers.

### Propylene $\alpha$ -Olefin Polymer

[0013] The propylene- $\alpha$ -olefin polymer described herein is a copolymer of propylene-derived units and one or more units derived from a C2 or C4-C20  $\alpha$ -olefin and optionally one or more diene-derived units. Preferred  $\alpha$ -olefins are ethylene, butene, hexene and octene.

[0014] Typical comonomer content of the polymer is from about 5 to about 35 wt%. In general, the comonomer content is adjusted so that the polymer preferably has a MWD of from about 1 to about 5, a heat of fusion less than or equal to 75 J/g and a  $T_m \leq 105$  °C. In some embodiments, where more than one comonomer is present, the amount of a particular comonomer may be < 5 wt%, but the combined comonomer content is preferably > 5 wt%.

[0015] In such an embodiment, when there is more than one alpha olefin-derived unit in the polymer, the total weight percent of the C2 or C4-C20 alpha olefin-derived units is preferably from about 5 wt% to about 35 wt%, more preferably from about 7 wt% to about 32 wt%, more preferably from about 8 wt% to about 25 wt%, more preferably from about 8 wt% to about 20 wt%, and more preferably from about 8 wt% to about 16 wt%. Particular embodiments of polymers having more than one alpha olefin include propylene-ethylene-octene, propylene-ethylene-hexene and propylene-ethylene-butene polymers. These polymers may further comprise a diene as described below.

[0016] The embodiments described below are discussed with reference to ethylene as a preferred comonomer, but such embodiments are equally applicable with butene, hexene or octene as a comonomer. The propylene-ethylene polymer described below comprises ethylene, propylene and optionally a diene.

[0017] The propylene-ethylene polymer can comprise from about 5 to about 25 wt% ethylene, preferably from about 5 to about 20 wt%, more preferably from about 5 to about 16 wt%, more preferably from about 5 to about 15 wt%, and

more preferably from about 6 to about 15 wt% ethylene. In a preferred embodiment, the propylene-ethylene copolymer comprises greater than 11 wt% ethylene.

[0018] The propylene-ethylene polymer can comprise from about 75 to about 95 wt% propylene, preferably from about 80 to about 95 wt%, more preferably from about 84 to about 95 wt%, more preferably from about 85 to about 95 wt%, and more preferably from about 85 to about 94 wt%.

[0019] The propylene-ethylene polymer may optionally comprise  $\leq 10$  wt% diene, preferably less than or equal to about 5 wt% diene, more preferably less than or equal to about 3 wt% diene, preferably from about 0.1 to about 3 wt%, more preferably from about 0.1 to about 2 wt%, and more preferably from about 0.1 to about 1 wt% diene. Suitable dienes useful as co-monomers are, for example: 1,4-hexadiene, 1,6 octadiene, 5-methyl-1,4-hexadiene, 3,7-dimethyl-1,6-octadiene, dicyclopentadiene (DCPD), ethylidene norbornene (ENB), norbornadiene, 5-vinyl-2-norbornene (VNB), and combinations thereof. The diene is most preferably ENB.

[0020] Preferred propylene-ethylene polymers have a triad tacticity, as measured by  $^{13}\text{C}$  NMR, of 75% or greater, 80% or greater, 82% or greater, 85% or greater, or 90% or greater. The triad tacticity of a polymer is the relative tacticity of a sequence of three adjacent propylene units, a chain consisting of head to tail bonds, expressed as a binary combination of m and r sequences. It is usually expressed for semi-amorphous copolymers as the ratio of the number of units of the specified tacticity to all of the propylene triads in the copolymer.

[0021] In a preferred embodiment, the propylene-ethylene polymer may have a heat of fusion ( $\Delta H_f$ ) which is greater than or equal to about 0.5 Joules per gram (J/g), and is less than or equal to about 70 J/g, preferably less than or equal to about 50 J/g, preferably less than or equal to about 35 J/g, preferably less than or equal to about 25 J/g. Preferably the propylene-ethylene polymers also have a

heat of fusion that is greater than or equal to about 1 J/g, preferably greater than or equal to about 2.5 J/g, preferably greater than or equal to about 5 J/g.

[0022] Thermodynamic heat of fusion data may be determined by differential scanning calorimetry (DSC), the procedure for which is as follows. About 6 to about 10 mg of a sheet of the polymer pressed at approximately 200 °C to 230 °C and cooled at ambient conditions (25°C and 50 % humidity for 24 hours) is removed with a punch die. This sample is annealed at room temperature for 80 to 100 hours. At the end of the annealing period, the sample is placed in a differential scanning calorimeter (Perkin Elmer 7 Series Thermal Analysis System) and cooled to -50 °C to -70 °C. The sample is then heated at a rate of 20 °C/min to a final temperature of 200 °C to 220 °C. The thermal output is recorded as the area under the melting peak curve of the sample, which is typically peaked at 30° C to 175° C, and occurs between the temperatures of 0 °C and 200 °C. The thermal output in joules is a measure of the heat of fusion.

[0023] In a preferred embodiment, the propylene-ethylene polymer has a % crystallinity of from 0.5 to 40, preferably 1 to 30, and more preferably 5 to 25 wherein % crystallinity is determined according to the DSC procedure described herein. For use herein, the crystallinity of the propylene-ethylene polymer can also be expressed in terms of percentage of crystallinity. The thermal energy for the highest order of polypropylene is estimated at 189 J/g (i.e., 100% crystallinity is equal to 189 J/g). In another embodiment, the propylene-ethylene polymer of the present disclosure preferably has a crystallinity of less than 40%, preferably about 0.25% to about 25%, more preferably from about 0.5% to about 22%, and most preferably from about 0.5% to about 20%.

[0024] In addition to this level of crystallinity, the propylene-ethylene polymer preferably has a single broad melting transition. The melting point is defined as the temperature of the greatest heat absorption within the range of melting of the sample. However, the propylene-ethylene polymer may show secondary melting peaks adjacent to the principal peak, but for purposes herein,

such secondary melting peaks are considered together as a single melting point, with the highest of these peaks being considered the melting point ( $T_m$ ) of the propylene-ethylene polymer. The propylene-ethylene polymer preferably has a melting point of from about 25 °C to 105 °C, preferably from 25 °C to about 85 °C, preferably from 25 °C to about 75 °C, preferably about 25 °C to about 65 °C, more preferably about 30 °C to about 80 °C, more preferably about 30 °C to about 70°C and more preferably about 30 °C to about 60 °C.

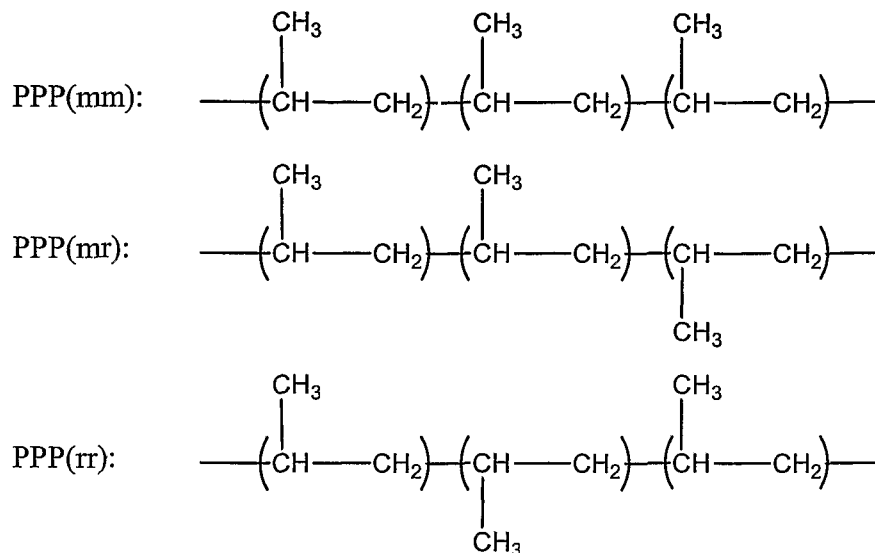
[0025] Preferred propylene-ethylene polymers may have a Mooney viscosity [ML (1+4) @ 125 °C] as determined according to ASTM D1646, of less than 100, more preferably less than 75, even more preferably less than 60, most preferably less than 30.

[0026] The molecular weight distribution index ( $MWD=(M_w/M_n)$ ) of the propylene-ethylene polymer may be about 1 to about 40, more preferably about 1 to about 5, more preferably about 1.8 to about 5 and most preferably about 1.8 to about 3. Techniques for determining the molecular weight ( $M_n$  and  $M_w$ ) and molecular weight distribution (MWD)- may be found in U.S. Pat. No. 4,540,753 (Cozewith, Ju and Verstrate) (which is incorporated by reference herein for purposes of U.S. practices) and references cited therein and in *Macromolecules*, 1988, volume 21, p 3360 (Verstrate et al.), which is herein incorporated by reference for purposes of U.S. practices, and references cited therein.

[0027] The triad tacticity (mm fraction) of a propylene-ethylene copolymer can be determined from a  $^{13}\text{C}$  NMR spectrum of the propylene-ethylene copolymer and the following formula:

$$\text{mm Fraction} = \frac{\text{PPP(mm)}}{\text{PPP(mm)} + \text{PPP(mr)} + \text{PPP(rr)}}$$

where PPP(mm), PPP(mr) and PPP(rr) denote peak areas derived from the methyl groups of the second units in the following three propylene unit chains consisting of head-to-tail bonds:



[0028] The  $^{13}\text{C}$  NMR spectrum of the propylene-ethylene polymer is measured as described in U.S. Patent No. 5,504,172. The spectrum relating to the methyl carbon region (19-23 parts per million (ppm)) can be divided into a first region (21.2-21.9 ppm), a second region (20.3-21.0 ppm) and a third region (19.5-20.3 ppm). Each peak in the spectrum was assigned with reference to an article in the journal Polymer, Volume 30 (1989), page 1350. In the first region, the methyl group of the second unit in the three propylene unit chain represented by PPP (mm) resonates. In the second region, the methyl group of the second unit in the three propylene unit chain represented by PPP (mr) resonates, and the methyl group (PPE-methyl group) of a propylene unit whose adjacent units are a propylene unit and an ethylene unit resonates (in the vicinity of 20.7 ppm). In the third region, the methyl group of the second unit in the three propylene unit chain represented by PPP (rr) resonates, and the methyl group (EPE-methyl group) of a propylene unit whose adjacent units are ethylene units resonates (in the vicinity of 19.8 ppm). The calculation of the triad tacticity is outlined in the techniques shown in U.S. Patent No. 5,504,172. Subtraction of the peak areas for the error in

propylene insertions (both 2,1 and 1,3) from peak areas from the total peak areas of the second region and the third region, the peak areas based on the 3 propylene units-chains (PPP(mr) and PPP(rr)) consisting of head-to-tail bonds can be obtained. Thus, the peak areas of PPP(mm), PPP(mr) and PPP(rr) can be evaluated, and hence the triad tacticity of the propylene unit chain consisting of head-to-tail bonds can be determined.

[0029] Preferred propylene-ethylene polymers are available commercially under the trade names Vistamaxx™ (ExxonMobil Chemical Company, Houston, TX, USA) and Versify™ (The Dow Chemical Company, Midland, Michigan, USA).

#### Conductor Shield Layer

[0030] The conductor shield layer is an electrically semi-conducting layer which causes the electric field to be uniform around the conductor. Methods and materials for making the conductor shield layer will be readily apparent to the skilled artisan. In a typical embodiment, the conductor shield layer preferably comprises ethylene-vinyl acetate (EVA), ethylene-ethyl acrylate (EEA), ethylene-propylene (EP) rubber, carbon black, and/or combinations of any two or more thereof. The conductor shield layer has a Ra surface roughness of about 0.1 to about 10 microns, more preferably about 0.1 to about 8 microns, more preferably from about 0.1 to about 5 microns, and more preferably from about 0.1 to about 3 microns. The conductor shield layer has a Rt surface roughness of about 5 to about 50 microns, more preferably from about 10 to about 40 microns, more preferably from about 20 to about 30 microns, and more preferably from about 5 to about 20 microns.

[0031] The surface roughness of the extrudate was measured using a Surfcom® 110 B surface gauge (manufactured by Tokyo Seimitsu Company). The Surfcom® instrument contains a diamond stylus which moves across the surface of the sample subject to evaluation. The instrument recorded the surface

irregularities over the length (assessment length) traveled by the diamond stylus.

This surface roughness was quantified in terms of two factors:

1.  $R_a$  ( $\mu\text{m}$ ), an arithmetic mean representing the departure of the extrudate surface profile from a mean line.
2.  $R_t$  ( $\mu\text{m}$ ), the vertical distance between the highest point and the lowest point of the extrudate roughness profile within the assessment length.

### Insulation Layer

[0032] In a typical embodiment, the insulation layer comprises preferably from about 2 to about 20 wt% propylene-alpha olefin polymer, preferably from about 3 to about 18 wt% propylene-alpha olefin polymer, preferably from about 4 to about 16 wt% propylene-alpha olefin polymer, preferably from about 5 to about 16 wt% propylene-alpha olefin polymer, and preferably from about 6 to about 16 wt% propylene-alpha olefin polymer. A preferred alpha olefin for the propylene-alpha olefin polymer used in the insulation layer is ethylene. In a typical embodiment, the insulation layer comprises suitable formulations such as those described in Examples 1, 2 or 3 (and may also comprise other materials such as tree retardant cross-linked low density polyethylene (TRXLPT), an ethylene-propylene rubber (EPR), or a copolymer of ethylene and a  $C_4+$  alpha-olefin, such as, for example, ethylene-butene, ethylene-hexene, or ethylene-octene copolymers). The insulation layer has a  $R_a$  surface roughness of about 0.1 to about 2 microns, more preferably about 0.1 to about 1.8 microns, more preferably from about 0.1 to about 1.5 microns, and more preferably from about 0.1 to about 1.0 microns. The insulation layer has a  $R_t$  surface roughness of about 8 to about 30 microns, more preferably from about 10 to about 25 microns, more preferably from about 15 to about 23 microns, and more preferably from about 15 to about 20 microns. The insulation layer may also include propylene-ethylene copolymers as described above and may also include EPDM.

### Insulation Shield Layer

[0033] In a typical embodiment, the insulation shield layer comprises an ethylene-propylene rubber (EPR), ethylene-vinyl acetate (EVA), ethylene-ethyl acrylate (EEA), low-density polyethylene (LDPE) and EVA blends, ethylene-propylene diene monomers (EPDM), carbon black and/or combinations of any two or more thereof. The insulation shield layer has a Ra surface roughness of about 0.1 to about 10 microns, more preferably about 0.1 to about 8 microns, more preferably from about 0.1 to about 5 microns, and more preferably from about 0.1 to about 3 microns. The insulation shield layer has a Rt surface roughness of about 5 to about 50 microns, more preferably from about 10 to about 40 microns, more preferably from about 20 to about 30 microns, and more preferably from about 5 to about 20 microns.

[0034] In an embodiment, the insulation shield layer comprises from about 2 to about 80 wt% propylene-alpha olefin polymer, based on the weight of the layer, preferably from about 3 to about 70 wt% propylene-alpha olefin polymer, preferably from about 4 to about 65 wt% propylene-alpha olefin polymer, preferably from about 4 to about 63 wt% propylene-alpha olefin polymer, and preferably from about 4 to about 60 wt% propylene-alpha olefin polymer. A preferred alpha olefin for the propylene-alpha olefin polymer used in the insulation shield layer is ethylene.

[0035] One or more of the layers described herein may comprise a second polymer. The second polymer may be selected from: propylene and propylene-ethylene homo-, co- or ter- polymers. In a preferred embodiment, the second polymer is EPDM and/or isotactic polypropylene. In one embodiment the second polymer is EPDM. In such embodiments the layers containing EPDM may contain from about 40 to about 99.9 wt% EPDM and from about 0.1 to about 60 wt% propylene-ethylene polymer, preferably from about 40 wt% to about 100 wt% EPDM and from about 0.1 wt% to about 60 wt% propylene-ethylene polymer, more preferably from about 5 to about 50 wt% EPDM, and from about 10 to about

40 wt% propylene-ethylene polymer. In some embodiments where there is no propylene-ethylene polymer, the layer may contain 100 wt% EPDM.

[0036] The formulation in the first layer or the second layer can also be blended with processing oil and other common additives such as nucleating agents, antioxidants, fillers, such as metal oxides, nano-compositions, and the like. Blends comprising propylene-ethylene polymers of this disclosure and other alpha-olefin polymers and copolymers, e.g., polypropylene may also be fabricated into objects used in a variety of applications. The additive(s) can be used not only in the first and second layers, but also in other places within the electrical device, such as, for example, the conductor (in which the additive can be inserted as a component of a filling composition), in an appropriate amount, which can be determined by the skilled in the art to provide the results of the disclosure.

[0037] Current day EPDM and EPM medium-voltage cable insulation typically employs lead oxide as an additive to ensure good electrical performance for many years. However, some applications seek similar performance without the presence of lead oxide. In one embodiment, it is desirable to make the electrical device lead-free, and substitute lead in one or more layers with suitable alternatives of other metal oxides, including but not limited to, manganese oxide, copper oxide, zinc oxide and bismuth oxide. As used herein, "lead-free" means essentially free of lead, which is less than 10 ppm, and preferably less than 5 ppm based on the weight of the compound used to extrude a particular layer.

[0038] In one embodiment, interfacial adhesion and bonding between the conductor-shield layer and the first layer or between the first layer and the optional second layer can be controlled according to the level of peroxide curative added to one or more of any of the layers.

[0039] This disclosure can be applied to any extruded products such as in tubestock and/or coverstock layers of hoses, in automotive weather stripping, and any other extruded product.

**Examples****Test Methods****Table 1**

Parameter	Units	Test
Mooney Viscosity	ML (1+4) @ 125° C, MU	ASTM D 1646
Oscillating Disk Rheometer (ODR) @ 200° C, 3°arc ML MH Cure State = (MH-ML) T <sub>s</sub> 2 T <sub>90</sub> T <sub>98</sub>	dNm dNm dNm/minute minute minute minute	ASTM D 2084
Physical Properties - press cured 20 min @ 165 °C Hardness Modulus 100%, 200%, 300% Tensile Strength Elongation at Break	Shore A MPa MPa %	ASTM D 2240 ASTM D 412-92 ASTM D 412-92 ASTM D 412-92
Tear Resistance	N/mm	ASTM D 624 - die C
Peak Load	N	ASTM D412

[0040] The samples were compression molded at 165 °C for 20 minutes at a force of about 15 U.S. tons (about 13.6 metric tons) into a plaque with dimensions of about 15 cm x 15 cm. The cooled plaques were removed, and the dumb bell specimens were die cut from this plaque per ASTM 412-92 recommended dimensions. The stress strain evaluation of the samples was conducted on an Instron 4465, made by Instron Corporation of 100 Royall Street, Canton, MA. The digital data was collected in a file collected by the Series IX Material Testing System available from Instron Corporation and analyzed using Excel 5, a spreadsheet program available from Microsoft Corporation of Redmond, WA. The elongation of the compounds was determined at a test speed of 50.8 cm/min (20 in/min) according to the procedure described in ASTM D790. The data was

reported in engineering units with no correction to the stress for the lateral contraction in the specimen due to tensile elongation.

[0041] Tear resistance between adjacent layers of compounds was tested by a strip-peel adhesion test. The test involves:

- (a) calendaring of each compound to 2.5 mm  $\pm$  0.1 mm (110 mils  $\pm$  5 mils) with temperatures of 95 °C for the top roll and 80 °C for the middle and bottom rolls;
- (b) preparation of test specimens by combining about 2.5 cm by 15 cm strips of the calendared compounds in a hydraulic press at the conditions of 165 °C for 20 minutes; and
- (c) measurement of the tear resistance between the layers with an Instron tensile-tester. A load cell weighing about 91 kilograms (200-lb) was Used in the Instron machine mentioned above with a crosshead speed of 50 mm/min and a total Instron jaw travel distance of 101.6 mm.

[0042] Compound extrusion studies were performed in a HAAKE Rheocord 90 single screw extruder. The screw length to diameter (L/D) for this extruder was 20/1. The extruder screw has a compression ratio of 2/1, which is typical for processing rubber compounds. A cylindrical die with a land length of 9.5 mm and diameter of 3.2 mm was used to assess surface appearance of the extrudates.

#### Materials Used

**Table 2**

Components	Description	Source
Translink 37	Calcined Clay	Englehard Corp. (Iselin, NJ)
Drimix A 172	Vinyl Silane	Kenrich Petrochemicals, Inc. (Bayonne, NJ)
Escorene LD 400	Low Density Polyethylene	ExxonMobil Chemical Company (Houston, TX)
IGI 1230	Refined paraffin wax	The International Group, Inc. (Wayne, PA)
Dicup 40 KE	Dicumyl peroxide on clay (40% Active)	Hercules Inc. (Wilmington, DE)
ERD 90	Red Lead	Rhein Chemie Corp. (Trenton, NJ)
XC-72 carbon black	Conductive black	Cabot Corp. (Atlanta, GA)

[0043] Polymer A was a propylene-ethylene copolymer having an ethylene content of about 16 wt%, a density of about 0.855 g/cm<sup>3</sup>, a MFR (230°C, 2.16 kg, ASTM 1238) of about 3 g/10 min, a melt index (MI) (190°C, 2.16 kg, ASTM D 1238) of about 1.3 g/10 min and a melting point of about 46°C. Polymer A is commercially available as Vistamaxx™ 1000 from ExxonMobil Chemical Company, Houston, TX, USA.

[0044] Polymer B was a propylene-ethylene copolymer composition having an ethylene content of about 11 wt%, a density of about 0.871 g/cm<sup>3</sup>, a MFR (230°C, 2.16 kg, ASTM 1238) of about 8 g/10 min, a MI (190°C, 2.16 kg, ASTM D 1238) of about 4 g/10 min, and a melting point of about 62°C. Polymer B is commercially available as Vistamaxx™ 3000 from ExxonMobil Chemical Company, Houston, TX, USA.

[0045] Polymer C was an EPDM elastomer with an ethylene content of about 76%, and an ENB content of about 3.3%, and a Mooney viscosity of about 24.

[0046] Polymer D was an EPDM elastomer with an ethylene content of about 76.1%, a VNB content of about 0.9%, and a Mooney viscosity of about 25.

[0047] Blend 1 was a blend of about 95 wt% Polymer A and about 5 wt% isotactic polypropylene having an MFR (230°C, 2.16 kg, ASTM 1238) of about 36 g/10 min, a density of about 0.9 g/cm<sup>3</sup> (ASTM 792) and a Mw/Mn of about 2.8. Blend 1 is commercially available as Vistamaxx™ 1100 from ExxonMobil Chemical Company, Houston, TX, USA.

[0048] Polymer A and Polymer B were produced according to the general procedure discussed in WO 0236651 (Example 1).

## Process

[0049] The formulations in Examples 1, 2 and 3 were made as follows. Table 3 shows the mixing procedure for the medium voltage electrical compound formulations of Examples 1, 2, and 3 containing 60 phr clay and other additives. The clay, Translink 37, was a calcined surface modified (vinyl modification) kaolin. AU of the compounding was performed in a 1600 cc Banbury internal mixer. The mix batch was sized to about 1450 gm to occupy the internal volume of the Banbury mixer. The compounds discharged from the Banbury mixer were sheeted out in a two roll mill. The peroxide was added in the mill to 300 grams of the compound. As used herein, "dump" was when the batch was discharged from the mixer. As used herein, "sweep" was when the ram was raised up while mixing to allow the batch to turn over completely. Sweep helps to incorporate the clay that was hung up on the ram during the addition into the mixer.

**Table 3**

<b>Time (minutes)</b>	<b>Rotor Speed (RPM)</b>	<b>Ingredients Addition</b>
0.0	85	Polymer, Agerite
0.5	85	1/2 Clay, Zinc Oxide, ERD 90, 1/2 Drimix, Escorene LD 400
2.0	100	1/4 Clay, 1/4 Drimix, 1/2 Wax
3.0	100	1/4 Clay, 1/4 Drimix, 1/2 Wax
4.0	100	Sweep
5.5	100	Sweep
7.0	Not applicable	Dump

[0050] The Examples were then tested for the properties as listed in Table 4 using the test methods as described herein.

**Table 4**

<b>Example</b>	<b>1</b>	<b>2</b>	<b>3</b>
<b>Components</b>			
Polymer C	100	100	100
Blend 1	---	12	---
Polymer B	---	---	12
Translink 37 Clay	60	60	60
Drimix A172 Silane	1.0	1.0	1.0
Zinc Oxide	5.0	5.0	5.0
Paraffin Wax 1230	5.0	5.0	5.0
Escorene LD 400	5.0	5.0	5.0
DiCup 40KE	6.5	6.5	6.5
Total parts by weight:	182.5	194.5	194.5
<b>ODR : 180°C</b>			
ML, dNm	8.32	7.86	7.90
MH, dNm	61.04	41.84	45.11
MH-ML, dNm	52.72	33.98	37.21
T <sub>g2</sub> , min	0.84	0.99	1.27
T <sub>90</sub> , min	4.23	4.00	4.48
T <sub>98</sub> , min	5.70	5.26	5.81
<b>Physical Properties</b>			
Hardness, Shore A	88	85	86
100% Modulus, MPa (psi)	4.8 (695)	3.9 (571)	4.1 (590)
200% Modulus, MPa (psi)	6.8 (984)	5.2 (749)	5.4 (789)
300% Modulus, MPa (psi)	8.0 (1161)	6.0 (863)	6.5 (938)
Tensile Strength, MPa (psi)	10.3 (1497)	10.2 (1478)	12.2 (1760)
Elongation at Break, %	578	715	724
<b>Surface Roughness</b>			
Ra, microns	1.38	0.86	1.95
Rt, microns	10.53	6.76	16.79

[0051] Example 1 was a typical medium voltage insulation compound. This formulation was based on Polymer C which was produced using a Ziegler-Natta catalyst. Also provided were alternative formulations in which 12 parts per hundred rubber (phr) of either Blend 1 (Example 2) or Polymer B (Example 3) were added to the reference formulation.

[0052] Table 4 provides oscillating disk rheometer (ODR) data for Examples 1, 2 and 3, stress/strain and hardness properties for the vulcanized compounds, and surface-roughness evaluations for unvulcanized ribbon samples, produced with a Haake laboratory extruder and a flat strip die.

[0053] The various zones of the extruder and the die block temperature were maintained constant at 125 °C. Granulated rubber was fed through the extruder hopper to maintain a full screw, but an empty hopper during extrusion. The extruder screw speed was varied from 25 rpm to 100 rpm. The mass throughput was measured at every screw speed by collecting a sample of the extrudate over a specific length of time, typically 10 to 30 seconds depending on the screw speed. At least three samples were collected to provide an average value.

[0054] The ODR results show reduced development of torque during vulcanization of Examples 2 and 3, (containing the products of Blend 1 and Polymer B), when compared to Example 1. The peak cure rates for Examples 2 and 3 were also slightly lower than for Example 1.

[0055] The stress/strain results were median values for five determinations. The results do not generally reflect the differences seen by ODR, and show that addition of Blend 1 or Polymer B does not lead to significant loss in two key properties: tensile strength and elongation at break. The low-strain modulus values for Examples 2 and 3 were slightly lower than for Example 1, which was directionally consistent with the ODR observation, but this result can be advantageous, as reduced low-strain modulus can provide improved cable flexibility.

[0056] The results also show that surface-roughness properties were greatly improved by addition of Blend 1. This finding highlights the unexpected nature of the reduction in surface roughness which occurs by addition of specialty propylene elastomers, and indicates the important attributes of the compositional makeup of Blend 1. The reduction in Ra and Rt values observed with addition of

Blend 1 reflects a significant improvement in surface roughness, which should provide better interfaces between the insulation layer and other component layers of typical wire and/or cable applications.

#### Examples 4-7

[0057] Table 5 provides the formulation for another reference medium-voltage insulation Example (4). This formulation was based on Polymer D.

[0058] Also provided in Table 5 are test formulations representing three semi-conductive shield Examples (5, 6, 7). Example 5 was based on Polymer D. Examples 6 and 7 were based on Blend 1, and also contained process oil.

[0059] The compounds of these examples were made in the manner described above. The Examples were then tested for peak load (N) and tear resistance (N/mm). The results for which are shown in Table 6.

[0060] Table 6 also provides results for the strip-peel adhesion test, as described herein, which compared insulation Example 4 with the three semi-conductive shield Examples 5, 6, and 7. The strip-peel adhesion test measured the tear resistance between adjacent layers of Example 4 with either Examples 5, 6, or 7. Thus, the pairs of Examples tested represent the following combinations:

- 4 / 5 is EPDM against EPDM
- 4 / 6 was EPDM against Blend 1 with 10 phr oil, and
- 4 / 7 was EPDM against Blend 1 with 20 phr oil.

The results clearly indicated improved adhesion (as measured by peak-load and tear-resistance) in the order  $4 / 7 > 4 / 6 > 4 / 5$ .

**Table 5**

<b>Examples</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>
<b>Components</b>				
Polymer D	100	100	---	---
Blend 1	---	---	100	100
Translink™ 37 Clay	60	---	---	---
XC-72 Carbon Black	---	60	60	60
Plastol 537	---	10	10	20
Drimix A172 Silane	1.0	---	---	---
Zinc Oxide	5.0	---	---	---
Paraffin Wax 1230	5.0	---	---	---
Escorene LD 400 (LDPE)	5.0	---	---	---
ERD-90	5.0	---	---	---
DiCup 40KE	6.5	---	---	---
Total phr:	187.5	170	170	180

**Table 6**

<b>Examples</b>	<b>4 / 5</b>	<b>4 / 6</b>	<b>4 / 7</b>
Peak Load, N	72.4	82.4	101.9
Tear Resistance, N / mm	2.0	2.4	3.1

[0061] Semi-conductive shield compounds based on EPDM are typically peroxide-cured. Examples 5, 6, and 7 were prepared without peroxide in order to test the potential for reduction or elimination of peroxide in the shield compound. The improved adhesion observed with the use of Blend 1 in Examples 6 and 7 (versus the use of EPDM in Example 5) could allow a reduction in the typical peroxide content for the shield compound.

## Claims

We Claim:

1. An electrical device comprising a conductor, a first layer over the conductor and/or a second layer over the first layer, wherein the first layer and/or the second layer comprises a propylene-alpha olefin polymer, wherein the propylene-alpha olefin polymer comprises from about 5 to about 25 wt% alpha olefin, from about 75 to about 95 wt% propylene and optionally <10 wt% diene, wherein the propylene-alpha olefin polymer has a MWD of from about 1 to about 5, a heat of fusion less than or equal to 75 J/g and a  $T_m \leq 105$  °C.
2. The electrical device of claim 1 wherein the first layer and/or the second layer comprises from about 5 to about 20 wt% propylene-alpha olefin polymer.
3. The electrical device of any of the preceding claims wherein the propylene-alpha olefin polymer comprises from about 5 to about 16 wt% ethylene.
4. The electrical device of any of the preceding claims wherein the propylene-alpha olefin polymer has a  $T_m$  of about 25 °C to about 105 °C.
5. The electrical device of any of the preceding claims wherein the propylene-alpha olefin polymer has a heat of fusion of from about 0.1 to about 70 J/g.
6. The electrical device of any of the preceding claims wherein the propylene-alpha olefin polymer has a triad tacticity of three polymer units of about 75% or greater.

7. The electrical device of any of the preceding claims wherein the electrical device comprises a conductor and a conductor shield layer, the first layer is an insulation layer, and the optional second layer is an insulation shield layer.
8. The electrical device of any of the preceding claims wherein the propylene-alpha olefin polymer further comprises 0.5 - 4 wt% diene and the diene is selected from a group consisting of ENB and VNB.
9. The electrical device of any of the preceding claims wherein the first layer and/or the second layer further comprises a second polymer.
10. The electrical device of Claim 9 wherein the second polymer is ethylene-and/or propylene-based.
11. The electrical device of Claim 9 wherein the second polymer is EPDM and is present from about 40 wt% to about 100 wt% and the propylene-ethylene polymer is present from about 0.1 wt% to about 60 wt%.
12. A process for making an electrical device comprising  
providing a conductor;  
extruding at least one layer over the conductor, wherein at least one of the layers comprises a propylene-alpha olefin polymer comprising from about 5 to about 25 wt% alpha olefin, from about 75 to about 95 wt% propylene and optionally  $\leq 10$  wt% diene; wherein the propylene-alpha olefin polymer has a MWD of from about 1 to about 5, a heat of fusion less than or equal to 75 J/g and a  $T_m < 105$  °C.
13. The process of claim 12 wherein the  $\alpha$ -olefin comprises one of more of ethylene, butene, hexene or octene.

14. The process according to claims 12 or 13 further comprising extruding at least a first layer and a second layer over the conductor.
15. The process of any of claims 12-14 wherein the second layer is over the first layer.
16. The process of any of claims 12-15 wherein the first layer comprises the propylene-alpha olefin polymer.
17. The process of any of claims 12-16 wherein the second layer comprises the propylene-alpha olefin polymer.
18. An electrical device comprising a conductor, a first layer over the conductor and/or a second layer over the first layer, wherein the first layer and/or the second layer comprises a propylene-ethylene polymer, wherein the propylene-ethylene polymer comprises from about 5 to about 25 wt% ethylene, from about 75 to about 95 wt% propylene and optionally <10 wt% diene, wherein the propylene-ethylene polymer has a MWD of from about 1 to about 5, a heat of fusion less than or equal to 75 J/g and a  $T_m \leq 105$  °C.
19. The electrical device of claim 18 wherein the first layer and/or the second layer comprises from about 5 to about 20 wt% propylene-ethylene polymer.
20. The electrical device of claims 18 or 19 wherein the propylene-ethylene polymer comprises from about 5 to about 16 wt% ethylene.
21. The electrical device of claims 18-20 wherein the propylene-ethylene polymer has a  $T_m$  of about 25 °C to about 105 °C.

22. The electrical device of claims 18-21 wherein the propylene-ethylene polymer has a heat of fusion of from about 0.1 to about 70 J/g.
23. The electrical device of claims 18-22 wherein the propylene-ethylene polymer has a triad tacticity of three polymer units of about 75% or greater.
24. The electrical device of claims 18-23 wherein the electrical device comprises a conductor and a conductor shield layer, the first layer is an insulation layer, and the optional second layer is an insulation shield layer.
25. The electrical device of claims 18-24 wherein the propylene-ethylene polymer further comprises 0.5 - 4 wt% diene and the diene is selected from a group consisting of ENB and VNB.
26. The electrical device of claims 18-25 wherein the first layer and/or the second layer further comprises a second polymer.
27. The electrical device of Claim 26 wherein the second polymer is ethylene- and/or propylene-based.
28. The electrical device of Claim 26 wherein the second polymer is EPDM and is present from about 40 wt% to about 100 wt% and the propylene-ethylene polymer is present from about 0.1 wt% to about 60 wt%.

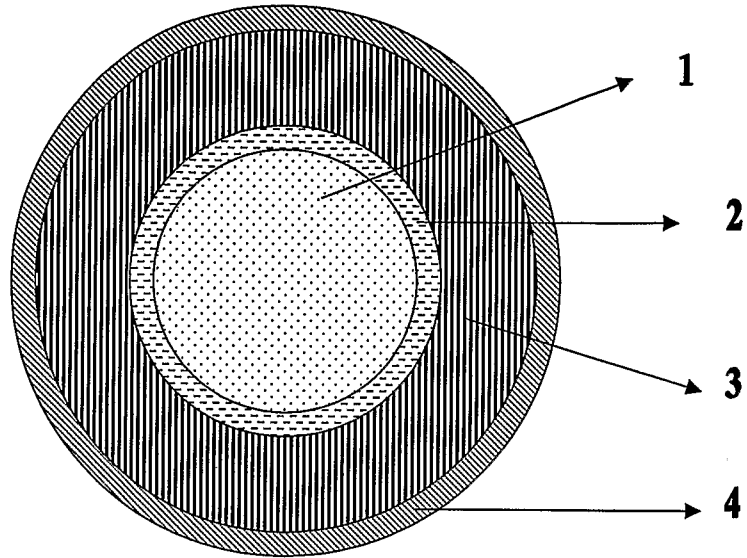


Figure 1

## INTERNATIONAL SEARCH REPORT

International application No  
PCT/US2006/044158

A CLASSIFICATIONpF SUBJECT MATTER  
INV. H01B3/44 C08L23/16

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

HOIB C08L

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and where practical search terms used)

EPO-Internal , WPI Data

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No
A	EP 1 223 191 A (EXXONMOBIL CHEMICAL PATENTS INC) 17 July 2002 (2002-07-17) paragraphs [0021] - [0024] paragraph [0010] - paragraph [0015] -----	1-28
A	EP 1 384 752 A (YAZAKI CORPORATION) 28 January 2004 (2004-01-28) paragraph [0013] paragraph [0018] claim 1 figure 1 -----	1-28



Further documents are listed in the continuation of Box C



See patent family annex

## \* Special categories of cited documents

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Date of the actual completion of the international search

16 April 2007

Date of mailing of the international search report

27/04/2007

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NL - 2280 HV Rijswijk  
Tel (+31-70) 340 2040 Tx 31 S51 epo nl  
Fax (+31-70) 340-3016

Authorized officer

Stinchcombe, John

# INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No

PCT/US2006/044153

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